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PRESS RELEASE

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UXV Technologies and ODU GmbH Signs Memorandum of Understanding on Development of Equipment for Next Generation Mounted and Dismounted Soldier Ecosystem

Washington, DC – *October 09, 2023* - UXV Technologies, a leading producer of technologies for unmanned systems and defense robotics, and ODU GmbH, a leading supplier of connector systems, are delighted to announce the signing of a Memorandum of Understanding for a strategic partnership for development of equipment for next generation mounted and dismounted soldier ecosystem, including data and power management hubs, high-performance connectors and associated equipment.

Today marks a significant milestone for UXV Technologies as they introduce two groundbreaking products within this soldier ecosystem: the HeXa Hub and the Pico Hub. These hubs are highly operational, advanced, and cost-effective solutions for soldier-mounted data and power management. These hubs are optimized for the Nett Warrior system and have been engineered for seamlessly integration with MOLLE, ensuring optimal utility and ergonomic comfort for soldiers in the field.

Earlier this year, UXV Technologies unveiled for the mounted and dismounted soldier ecosystem the <u>Soldier Borne Compute Module</u>, a dynamic data and power management hub offering the option of an integrated Nvidia or ModalAl computer and compatibility with Swappable Radio Modules (SRMs).

ODU will supply high-performance connectors for products within the mounted and dismounted soldier ecosystem. Commenting on the partnership, Robert Klemisch, Managing Director of ODU GmbH, expressed his enthusiasm: "I am very excited to embark on this partnership with UXV Technologies. A collaboration with a pioneer in unmanned systems and defense robotics is a crucial step in our journey to enhance the integration of high-performance connectors."

Steven Friberg, CEO of UXV Technologies, also shared his excitement about the partnership's potential: "Today, we are taking a significant leap forward in advancing the



equipment for the next generation of the mounted and dismounted soldier ecosystem. UXV is committed to providing pioneering innovations within this domain to deliver cost-effective, high-performance equipment to end-users. With this Memorandum of Understanding, we are strengthening our collaboration with ODU, and I am excited about the prospects that this partnership can bring."

About UXV Technologies: UXV Technologies designs, develops and manufacturers drone and robotics technology for business and government clients. We are specialized in command and control (ground control stations) solutions and sensors for a wide range of unmanned applications, including UAVs, UGVs, ASVs and subsea ROVs. With headquarters based in Denmark and additional offices in the US, we believe in the power of nurturing strong partnerships with our customers by investing in understanding their products and services.

ODU Group: global representation with perfect connections

The ODU Group is one of the world's leading suppliers of connector systems, employing 2,600 people around the world. In addition to its company headquarters in Muehldorf a. Inn (Germany), ODU also has an international distribution network, production and product development sites in Sibiu/Romania, Shanghai/China, Tijuana/Mexico and Camarillo/USA. ODU combines all relevant areas of expertise and key technologies including design and development, machine tooling and special machine construction, injection, stamping, turning, surface technology, assembly and cable assembly. The ODU Group sells its products globally through its sales offices in Austria, China, Denmark, France, Germany, Hong Kong, Italy, Japan, Korea, Sweden, UK and the US, as well as through numerous international sales partners. ODU connectors ensure a reliable transmission of power, signals, data and media for a variety of demanding applications including medical technology, military and security, automotive, industrial electronics, and test and measurement.